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Supplement 1

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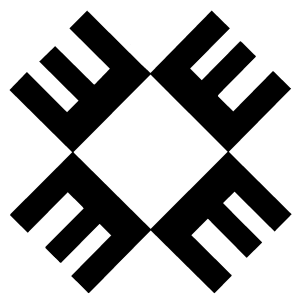
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LIST OF ARTICLES BY SUBJECT CATEGORY

ANTENNAS AND PROPAGATION

Microstrip Antennas

APPLIED SUPERCONDUCTIVITY

High- T_C Superconductors, Physical Structures, and Role of Constituents

Hysteresis and Coupling Losses in Superconductors
Superconductors, Forced Flow Conductor Manufacturing
Superconductors: Processing of High- T_C Bulk, Thin Film, and Wires

Tunneling and Josephson Junctions

BIOMEDICAL ENGINEERING

Bioimpedance

Physiological Models Survey

CIRCUITS AND SYSTEMS: ANALOG AND DIGITAL SIGNAL PROCESSING

Pulse-Shaping Circuits

Voltage-Frequency Converters

CIRCUITS AND SYSTEMS: FUNDAMENTAL THEORY AND APPLICATIONS

Stability of Nonlinear Systems

COMMUNICATIONS

Continuous-Phase Modulation

Telephone Traffic

COMPUTATIONAL SCIENCE AND ENGINEERING

Describing Functions

Equation Manipulation

Random Matrices

COMPUTERS

Bit-Slice Computers

ELECTRON DEVICES

Quantum Devices

Vacuum Microelectronics

ENERGY CONVERSION

Primary Cells

IMAGE PROCESSING

Image Reconstruction

INDUSTRY APPLICATIONS

Harmonics and Power Phenomena

INFORMATION THEORY

Information Theory of Stochastic Processes

INSTRUMENTATION AND MEASUREMENT

Altimeters

Ellipsometry, Variable Angle Spectroscopic

Voltmeters

MAGNETICS

Computational Magnetostatics

Magnetic Fluids

Magnetic Separation

Magnetic Thin Films

MEDICAL IMAGING

Medical Image Processing

MICROWAVE THEORY AND TECHNIQUES

Frequency Converters and Mixers
Microwave Solid State Devices
Planar Dielectric Leaky-Wave Antennas
Waveguide Discontinuities

NETWORKING

Network Security Framework
Wireless Networks

PARALLEL AND DISTRIBUTED SYSTEMS

Message-Passing Software Systems
Real-Time Object-Oriented Distributed Computing

PATTERN ANALYSIS AND MACHINE INTELLIGENCE

Natural Language Understanding
Object Recognition

PLASMA SCIENCE

Plasma Switches

POWER DELIVERY

Underground Cables

POWER ELECTRONICS

Insulated Gate Bipolar Transistors
Transistors, Bipolar Junction

PROFESSIONAL COMMUNICATIONS

Advanced Publishing Technologies and Services
Professional Journal Articles

QUANTUM ELECTRONICS

Distributed Bragg Reflector Lasers

SEMICONDUCTOR MANUFACTURING

Focused Ion Beams in Semiconductor Manufacturing

SIGNAL PROCESSING

Optical Information Processing
Radar Signal Processing

SOFTWARE ENGINEERING

Application Generators
Software Development Management

**ULTRASONICS, FERROELECTRICS,
AND FREQUENCY CONTROL**

Nondestructive Evaluation
Therapeutic Ultrasound

VEHICULAR TECHNOLOGY

Ground Transportation Systems
Mobile Radio Channels

LIST OF ARTICLES

- Advanced Publishing Technologies and Services
Altimeters
Application Generators
- Bioimpedance
Bit-Slice Computers
- Computational Magnetostatics
Continuous-Phase Modulation
- Describing Functions
Distributed Bragg Reflector Lasers
- Ellipsometry, Variable Angle Spectroscopic
Equation Manipulation
- Focused Ion Beams in Semiconductor Manufacturing
Frequency Converters and Mixers
- Ground Transportation Systems
- Harmonics and Power Phenomena
High- T_c Superconductors, Physical Structures, and Role of
Constituents
Hysteresis and Coupling Losses in Superconductors
- Image Reconstruction
Information Theory of Stochastic Processes
Insulated Gate Bipolar Transistors
- Magnetic Fluids
Magnetic Separation
Magnetic Thin Films
Medical Image Processing
Message-Passing Software Systems
Microstrip Antennas
Microwave Solid State Devices
Mobile Radio Channels
- Natural Language Understanding
Network Security Framework
Nondestructive Evaluation
- Object Recognition
Optical Information Processing
- Physiological Models Survey
Planar Dielectric Leaky-Wave Antennas
Plasma Switches
Primary Cells
Professional Journal Articles
Pulse-Shaping Circuits
- Quantum Devices
- Radar Signal Processing
Random Matrices
Real-Time Object-Oriented Distributed Computing
- Software Development Management
Stability of Nonlinear Systems
Superconductors, Forced Flow Conductor Manufacturing
Superconductors, Processing of High- T_c Bulk, Thin Film, and
Wires
- Telephone Traffic
Therapeutic Ultrasound
Transistors, Bipolar Junction
Tunneling and Josephson Junctions
- Underground Cables
- Vacuum Microelectronics
Voltage-Frequency Converters
Voltmeters
- Waveguide Discontinuities
Wireless Networks

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